### NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE2312A uses advanced trench technology to provide excellent  $R_{\rm DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

•  $V_{DS} = 20V, I_D = 5A$ 

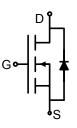
 $R_{DS(ON)}$  < 35m $\Omega$  @  $V_{GS}$ =2.5V

 $R_{DS(ON)}$  < 28m $\Omega$  @  $V_{GS}$ =4.5V

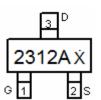
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

## **Application**

- Battery protection
- Load switch
- Power management



Schematic diagram



Marking and pin assignment



SOT-23 top view

## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2312A X	NCE2312A	SOT-23	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T<sub>A</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	20	V
Gate-Source Voltage	V <sub>GS</sub>	±10	V
Drain Current-Continuous	I <sub>D</sub>	5	Α
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	15	Α
Maximum Power Dissipation	P <sub>D</sub>	1.25	W
Operating Junction and Storage Temperature Range	$T_{J},T_{STG}$	-55 To 150	$^{\circ}$

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	100	°C/W

#### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	20	22	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V	-	-	1	μA





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# **NCE2312A**

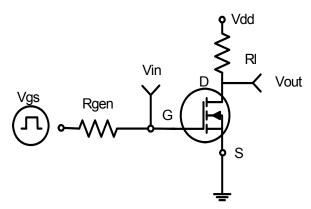
Parameter	Symbol Condition		Min	Тур	Max	Unit
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	0.5	0.65	1.0	V
Drain Course On Otata Basistana		V <sub>GS</sub> =2.5V, I <sub>D</sub> =4.5 A	-	20	35	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A	-	17	28	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =15V,I <sub>D</sub> =5A	25	-	-	S
Dynamic Characteristics (Note4)	<u>.</u>					
Input Capacitance	C <sub>lss</sub>	)/ 40)/)/ 0)/	-	780	900	PF
Output Capacitance	Coss	- V <sub>DS</sub> =10V,V <sub>GS</sub> =0V, - F=1.0MHz	-	140	160	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UMHZ	-	80	92	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	9	15	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =10V, $I_D$ =1A	-	30	45	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =4.5 $V$ , $R_{GEN}$ =6 $\Omega$	-	35	55	nS
Turn-Off Fall Time	t <sub>f</sub>		-	10	15	nS
Total Gate Charge	Qg		-	11	15	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =10V,I <sub>D</sub> =5A,V <sub>GS</sub> =4.5V	-	2.3	4	nC
Gate-Drain Charge	$Q_{gd}$		-	2.9	5	nC
Drain-Source Diode Characteristics	•	•				-
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =5A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	5	Α

#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production



## **Typical Electrical and Thermal Characteristics**



**Figure 1:Switching Test Circuit** 

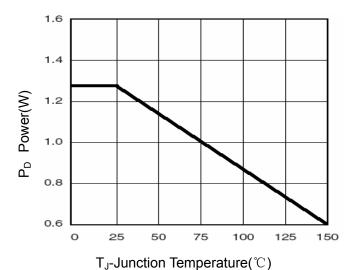
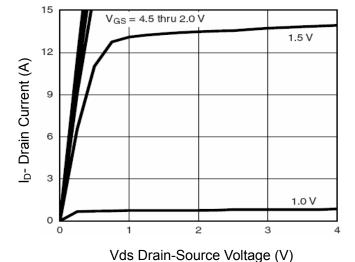


Figure 3 Power Dissipation



**Figure 5 Output Characteristics** 

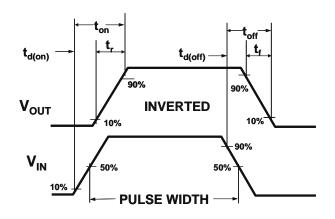
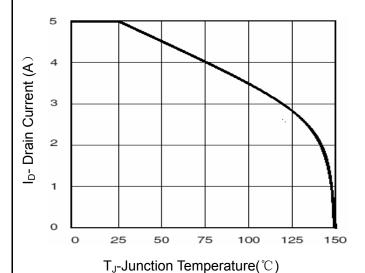


Figure 2:Switching Waveforms



**Figure 4 Drain Current** 

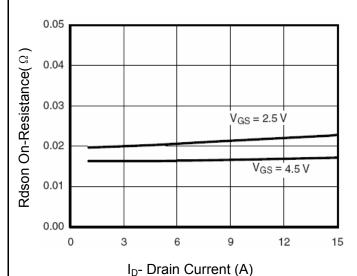
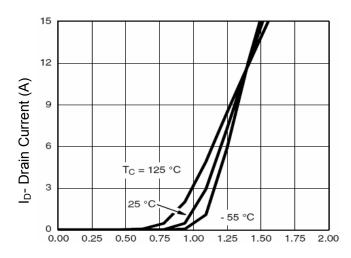


Figure 6 Drain-Source On-Resistance

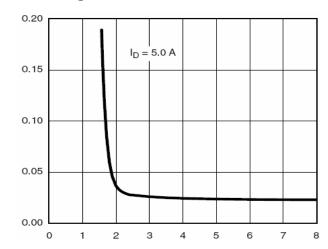


Rdson On-Resistance( (2)



Vgs Gate-Source Voltage (V)

**Figure 7 Transfer Characteristics** 



Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs

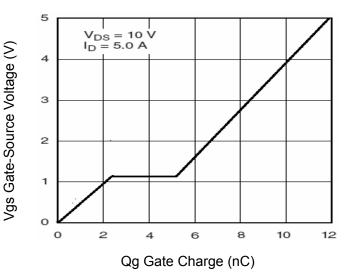


Figure 11 Gate Charge

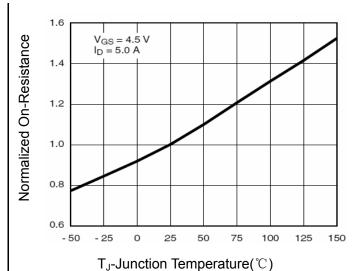


Figure 8 Drain-Source On-Resistance

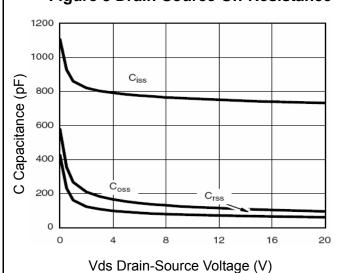


Figure 10 Capacitance vs Vds

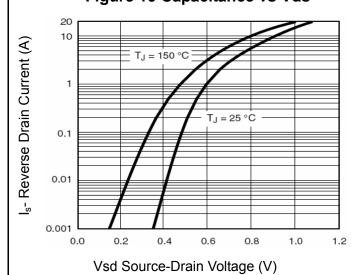
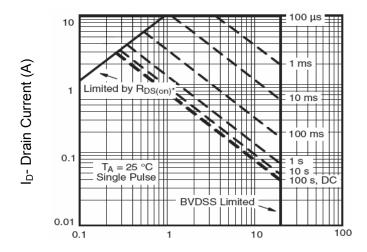


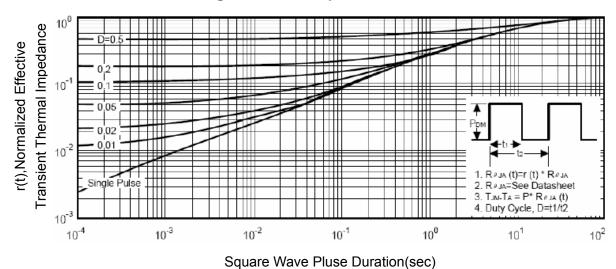
Figure 12 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)

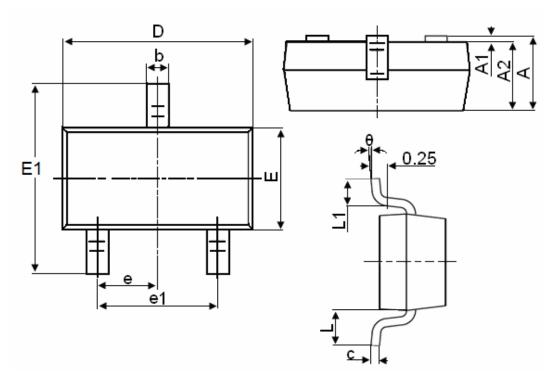
**Figure 13 Safe Operation Area** 



**Figure 14 Normalized Maximum Transient Thermal Impedance** 

## **SOT-23 Package Information**

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Cumbal	Dimensions in Millimeters					
Symbol	MIN.	MAX.				
А	0.900	1.150				
A1	0.000	0.100				
A2	0.900	1.050				
b	0.300	0.500				
С	0.080	0.150				
D	2.800	3.000				
E	1.200	1.400				
E1	2.250	2.550				
е		0.950TYP				
e1	1.800	2.000				
L		0.550REF				
L1	0.300	0.500				
θ	0°	8°				

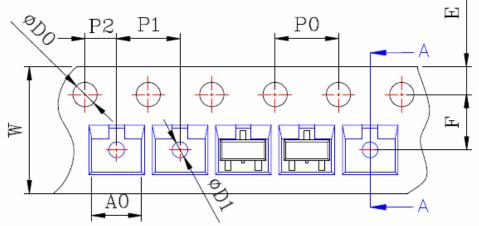
#### Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- $5. \ Controlling \ dimension \ is \ millimeter, \ converted \ inch \ dimensions \ are \ not \ necessarily \ exact.$

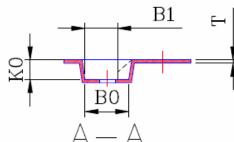


# NCE2312A

## **Packing Specification**



	產品尺寸規格								
規格	w	P1	E	F	D0	D1	PO		
<b>长</b> 4	8 <sup>+0.3</sup> -0.1	4±0.1	1.75±0.1	3.5±0.05	ø1.5 ±0.1	ø1.0 +0.25	4 ±0.1		
規格	A0	В0	B1	K0	T	P2			
尺寸	3.15±0.1	2.77±0.1	2.06±0.1	1.22±0.1	0.20±0.02	2±0.05			





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